

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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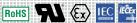






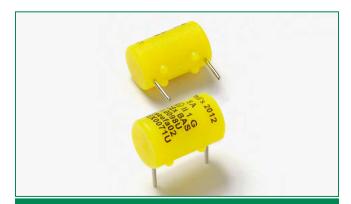
PICO® 259 Series Safe-T-Plus Fuse











Agency Approvals

Agency	Agency File Number	Ampere Range	
⟨Ex⟩	Baseefa02ATEX0071U	0.062A - 5A	
IEC IECEX	IECEx BAS 10.0098U	0.062A - 5A	
71 2	E10480	0.062A - 5A	

Electrical Characteristics for Series

	% of Ampere Rating	Opening Time
ĺ	100%	4 Hours, Minimum
	200%	5 Seconds, Maximum

Reference Standards

Agency	Standards		
ATEX	EN 60079-0, EN 60079-11		
IECEx	IEC 60079-0, IEC 60079-11		

Description

The Safe-T-Plus 259 Series offers a range of encapsulated fuses designed to enable greater safety for operating electronic equipment within potentially explosive environments. Originally designed to serve the needs of gas plants, petrochemical and processing industries, these fuses are certitifed for use within intrinsically safe apparatus with ATEX and IECEx certifications.

The fuse design and its encapsulant are suitable for use in intrinsically safe appartatus and associated apparatus for voltage not exceeding 125V rms (190V peak).

Features

- Encapsulated and sealed (1mm minimum)
- 0.062A 5A range options RoHS compliant
- Designed to operate within environments where there is danger of gas explosion from faulty
- ATEX and IECEx certified components

Applications

circuits

• Testing, measuring or processing electronic and electrical equipment

Additional Information







Resources

Samples

Electrical Specifications by Items

Ampere	Amp		Nominal	Minimum Cold		Nominal Cold	Agency Approvals		
Rating (A)	Code		Melting Resistance at I ² t (A ² Sec.) -20°C (Ohms)	Resistance at -40°C (Ohms)	Resistance at 25°C (Ohms)	⟨Ex⟩	IEC TECEX	AI .	
0.062	.062		0.00011	4.89	4.39	7.00	Х	Х	Х
0.125	.125		0.0012	1.35	1.26	1.70	X	x	X
0.250	.250		0.0095	0.51	0.48	0.665	X	Х	X
0.375	.375	50A @ 125 VAC	0.025	0.32	0.29	0.395	X	Х	Х
0.500	.500	300A @ 125 VDC	0.0598	0.24	0.22	0.302	X	X	Х
0.750	.750		0.153	0.14	0.12	0.175	X	х	X
1.00	001.		0.256	0.10	0.07	0.128	X	Х	X
3.00	003.		1.27	0.03	0.01	0.03	Х	Х	X
5.00	005.	50A @ 125 VAC 300A @ 63 VDC	4.14	0.01	0.005	0.0158	х	х	х

¹⁾ The fuse must be so mounted that creepage and clearance distances aren't impaired in any way.

²⁾ The fuse is suitable for use in intrinsically safe equipment for voltages not exceeding 190V peak.

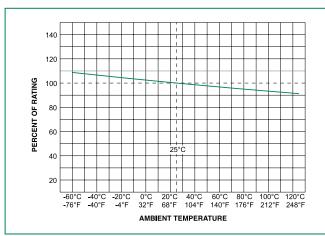
3) Maximum surface temperature rise at 170% rated current: <750mA=40°C, 1A=55°C, 3A=118°C and 5A=135°C.



Product Characteristics

Materials	Body : Polyamide Terminals - Tin Plated Copper Alloy Max. operating temperature of materials 130°C	
Operating Temperature	Operating temperature depends on fuse rating and max. allowed fuse surface temperature. (Consider re-rating)	
Thermal Shock	Withstands 5 cycles of – 55°C to 125°C	
Vibration	Per MIL-STD-202, Method 201	
Insulation Resistance (After Opening)	Greater than 10,000 ohms	

Temperature Re-rating Curve



Note:

Soldering Parameters

Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation	
Preheat: (Depends on Flux Activation Temperature)	(Typical Industry Recommendation)	
Temperature Minimum:	100°C	
Temperature Maximum:	150°C	
Preheat Time:	60-180 seconds	
Solder Pot Temperature:	260°C Maximum	
Solder DwellTime:	2-5 seconds	

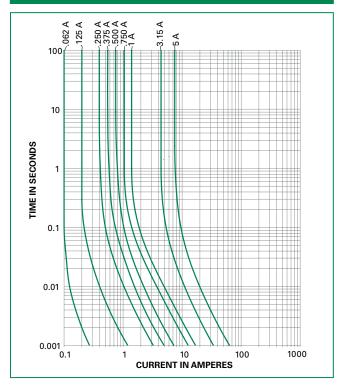
Recommended Hand Soldering Parameters:

Solder Iron Temperature: 350°C +/- 5°C

Heating Time: 5 seconds max.

Note: These devices are not recommended for IR or Convection Reflow process

Average Time Current Curves



Part Numbering System

0259.062M

SERIES —

AMP Code

The dot is poisitioned before the Packaging Suffix with whole ratings and within the numbering sequence for fractional ratings. Refer to Amp Code column in the Electrical Specifications table.

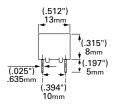
PACKAGING Code

M = Bulk pack, 1000 pcs T = Bulk pack, 10 pcs

Example:

1 amp product is 0259**001.**M (.062 amp product shown).

Dimensions



Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
Bulk	N/A	1000	M = Bulk 1000 pieces, T = Bulk 10 pieces
Bulk	N/A	10	Please refer to available quantities above in "Part Numbering System"

Re-rating depicted in this curve is in addition to the standard derating of 25% for continuous operation.